	Material Comp © Copyright 2005. I international and Par	PC, Bannockt	ourn, Illinois. A	All rights reserved u ntions.	nder both	This docume level parts, t	ent is a declara he declaration	ation on enco	of the substances ompasses all lowe	within th er level m	e manufactur aterials for w	er listed i hich the n	tem. Note: if nanufacturer	the item is an as has engineering	ssembly with lowe responsibility.	
1752-21.1					Form Type Distribute						neous Materi	ials and Mfg Information				
Supplier	r Information															
Company	name*	Company unique ID			1	Unique ID Authority					Response Date*					
onsemi												2024-04-19				
Contact N	ame		Title - Contact]	Phone - Contact*					Email - Contact*				
Product-E	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Authorized	d Representative*		Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-E	Env-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item FFPF155 FFPF155						Effective Date Version Manufacturing Si 2024-04-19 CPA		uring Site	Weight* 1978.421		UOM	Unit Type			
												mg	Each			
Aanufa	cturing Proccess Informa	tion					·									
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020		J-STD-020 MSI	L Rating	Peak Process I		s Body Temperature Max Time at Peak		Temperature Number		er of Reflow Cy	cles		
	Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30 seco		secon	ds 3					
Comments																
or more i	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	IS RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).									
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the							
Supplier Digital Signature	astislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.81	mg	Supplier	Silicon (Si)	7440-21-3		2.81	mg
Die Attach Solder	1.111	mg	Supplier	Silver (Ag)	7440-22-4		0.0278	mg
			А	Lead (Pb)	7439-92-1	7a	1.0277	mg
			Supplier	Tin (Sn)	7440-31-5		0.0555	mg
lead Frame	1444.76	mg	В	Nickel (Ni)	7440-02-0		14.3031	mg
			Supplier	Iron (Fe)	7439-89-6		2.1527	mg
			Supplier	Copper (Cu)	7440-50-8		1427.004	mg
			Supplier	Phosphorus (P)	7723-14-0		1.3002	mg
Iold Compound-Black	518.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		103.68	mg
			Supplier	Carbon Black (C)	1333-86-4		5.184	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		409.536	mg
lating	8.9	mg	Supplier	Tin (Sn)	7440-31-5		8.9	mg
Wire Bond - Al	2.44	mg	Supplier	Aluminum (Al)	7429-90-5		2.44	mg